

# N-ChannelEnhancement Mode Power MOSFET

### **Description**

The RM3416 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications .It is ESD protested.

#### **General Features**

V<sub>DS</sub> = 20V,I<sub>D</sub> =6.5A

 $R_{DS(ON)}$  <40m $\Omega$  @  $V_{GS}$ =1.8V

 $R_{DS(ON)}$  <33m $\Omega$  @  $V_{GS}$ =2.5V

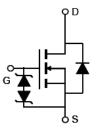
 $R_{DS(ON)}$  <27m $\Omega$  @  $V_{GS}$ =4.5V

ESD Rating: 2000V HBM

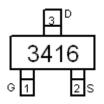
- High Power and current handing capability
- Lead free product is acquired
- Surface mount package

## **Application**

- PWM application
- Load switch



Schematic diagram



Marking and pin assignment



SOT-23 top view

#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
3416	RM3416	SOT-23	Ø180mm	8mm	3000 units

# Absolute Maximum Ratings (T<sub>A</sub>=25℃unless otherwise noted)

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Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	20	V		
Gate-Source Voltage	Vgs	±12	V		
Drain Current-Continuous	I <sub>D</sub>	6.5	А		
Drain Current-Pulsed (Note 1)	I <sub>DM</sub>	30	Α		
Maximum Power Dissipation	P <sub>D</sub>	1.4	W		
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	$^{\circ}$ C		

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	89	°C/W
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### Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	20		-	V

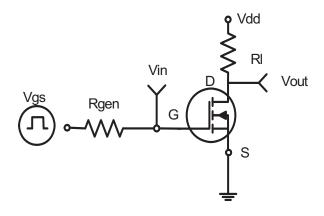
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =20V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±10V,V <sub>DS</sub> =0V	-	-	±10	μΑ
On Characteristics (Note 3)				•		
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	0.45	0.7	1.0	V
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =6.5A	-	17	27	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =2.5V, I <sub>D</sub> =5.5A	-	21	33	mΩ
		V <sub>GS</sub> =1.8V, I <sub>D</sub> =5A	-	28	40	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =6.5A	8	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	V <sub>DS</sub> =10V,V <sub>GS</sub> =0V, F=1.0MHz	-	660	-	PF
Output Capacitance	C <sub>oss</sub>		-	160	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	7 F-1.0IVID2	-	87	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	0.5		nS
Turn-on Rise Time	t <sub>r</sub>	V <sub>DD</sub> =10V,R <sub>L</sub> =1. 5Ω	-	1		nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =5V, $R_{GEN}$ =3 $\Omega$	-	12		nS
Turn-Off Fall Time	t <sub>f</sub>		-	4		nS
Total Gate Charge	Qg	V <sub>DS</sub> =10V,I <sub>D</sub> =6.5A,	-	8		nC
Gate-Source Charge	Q <sub>gs</sub>		-	2.5	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	- V <sub>GS</sub> =4.5V	-	3	-	nC
Drain-Source Diode Characteristics					•	•
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =6.5A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	6.5	Α
		1				

#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- Surface Mounted on FR4 Board, t ≤ 10 sec.
  Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production



# **RATING AND CHARACTERISTICS CURVES (RM3416)**



**Figure 1:Switching Test Circuit** 

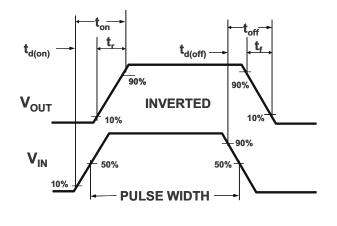
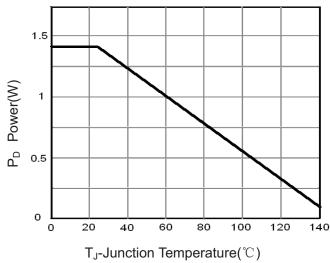


Figure 2:Switching Waveforms



**Figure 3 Power Dissipation** 

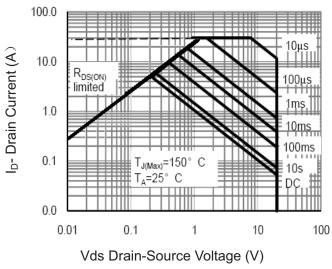
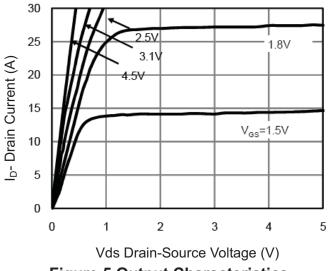


Figure 4 Safe Operation Area



**Figure 5 Output Characteristics** 

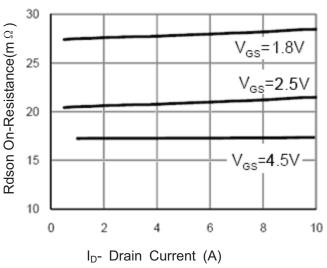
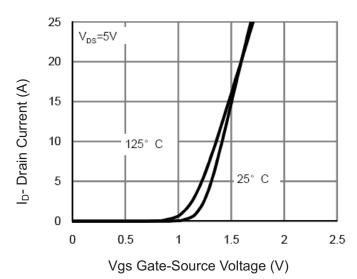


Figure 6 Drain-Source On-Resistance



### RATING AND CHARACTERISTICS CURVES (RM3416)



**Figure 7 Transfer Characteristics** 

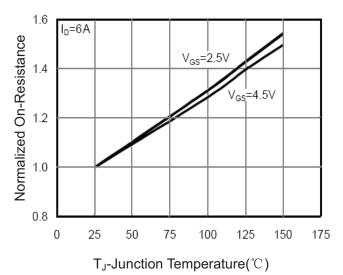


Figure 8 Drain-Source On-Resistance

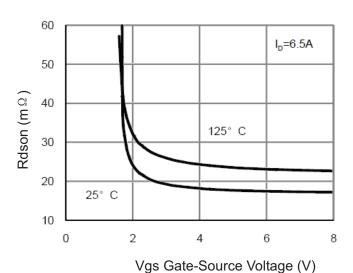


Figure 9 Rdson vs Vgs

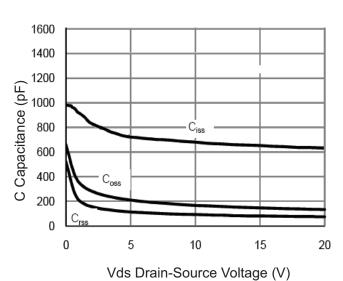


Figure 10 Capacitance vs Vds

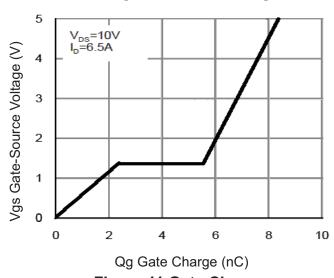


Figure 11 Gate Charge

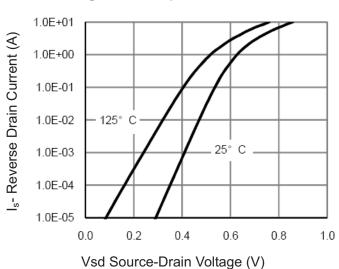


Figure 12 Source- Drain Diode Forward



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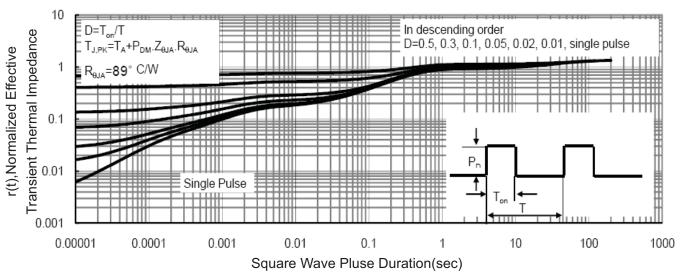
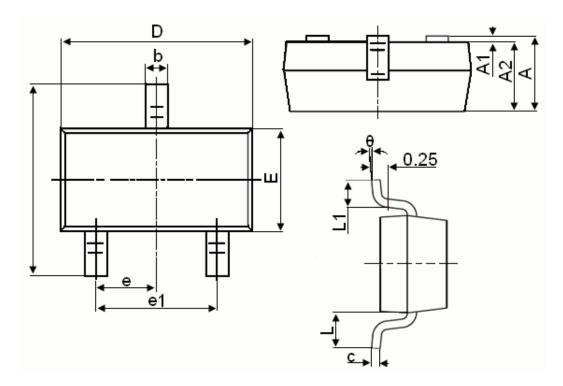


Figure 13 Normalized Maximum Transient Thermal Impedance



# **SOT-23 Package Information**



Symbol	Dimensions in Millimeters				
Symbol	MIN.	MAX.			
А	0.900	1.150			
A1	0.000	0.100			
A2	0.900	1.050			
b	0.300	0.500			
С	0.080	0.150			
D	2.800	3.000			
E	1.200	1.400			
E1	2.250	2.550			
е		0.950TYP			
e1	1.800	2.000			
L		0.550REF			
L1	0.300	0.500			
θ	0°	8°			

#### Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance ±0.10mm (4 mil) unless otherwise specified
- $3.\ Package\ body\ sizes\ exclude\ mold\ flash\ and\ gate\ burrs.\ Mold\ flash\ at\ the\ non-lead\ sides\ should\ be\ less\ than\ 5\ mils.$
- 4. Dimension L is measured in gauge plane.
- 5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.



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